

Global Bonding Wires for Power Device Market 2025 by Manufacturers, Regions, Type and Application, Forecast to 2031

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Abstracts

According to our (Global Info Research) latest study, the global Bonding Wires for Power Device market size was valued at US\$ 1399 million in 2024 and is forecast to a readjusted size of USD 2530 million by 2031 with a CAGR of 9.3% during review period.

Bonding wire, as the core inner lead material in the packaging process, is an indispensable basic component in the manufacturing process of integrated circuits and discrete semiconductor devices. It specifically refers to the fine metal wire used to electrically connect the bonding points of the internal circuit of the chip with the internal contact points of the lead frame through wire bonding technology during the assembly process of semiconductor devices and integrated circuits. Bonding wire for power devices mainly refers to bonding wire used for devices such as IGBT and MOSFET.

This report is a detailed and comprehensive analysis for global Bonding Wires for Power Device market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Bonding Wires for Power Device market size and forecasts, in consumption value (\$ Million), sales quantity (M Meter), and average selling prices (USD/K Meter), 2020-2031

Global Bonding Wires for Power Device market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (M Meter), and average selling prices (USD/K Meter), 2020-2031

Global Bonding Wires for Power Device market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (M Meter), and average selling prices (USD/K Meter), 2020-2031

Global Bonding Wires for Power Device market shares of main players, shipments in revenue (\$ Million), sales quantity (M Meter), and ASP (USD/K Meter), 2020-2025

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for Bonding Wires for Power Device

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global Bonding Wires for Power Device market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include TANAKA Precious Metals, Heraeus, Nippon Micrometal Corporation, TATSUTA Electric Wire & Cable, Precision Packaging Materials, MK Electron, LT Metal, Niche-Tech, Microbonds, AMETEK Coining, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Bonding Wires for Power Device market is split by Type and by Application. For the period 2020-2031, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market segment by Type

- Aluminum Bonding Wire
- Copper Bonding Wire
- Silver Bonding Wire
- Gold Bonding Wire

Market segment by Application

- IGBT
- MOSFET
- Others

Major players covered

- TANAKA Precious Metals
- Heraeus
- Nippon Micrometal Corporation
- TATSUTA Electric Wire & Cable
- Precision Packaging Materials
- MK Electron
- LT Metal
- Niche-Tech
- Microbonds
- AMETEK Coining
- Shanghai MATFRON
- Shanghai Wonsung
- Ningbo Kangqiang Electronics
- Zhejiang Yipu
- Sichuan Winner
- Yantai Zhaojin Kanfort Precious Metals Co., Ltd
- Yantai Yesno
- Jiangsu Jincan Electronics
- Sigma

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Bonding Wires for Power Device product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Bonding Wires for Power Device, with price, sales quantity, revenue, and global market share of Bonding Wires for Power Device from 2020 to 2025.

Chapter 3, the Bonding Wires for Power Device competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Bonding Wires for Power Device breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2020 to 2031.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2020 to 2031.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2020 to 2025. and Bonding Wires for Power Device market forecast, by regions, by Type, and by Application, with sales and revenue, from 2026 to 2031.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Bonding Wires for Power Device.

Chapter 14 and 15, to describe Bonding Wires for Power Device sales channel, distributors, customers, research findings and conclusion.

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